

Low Loss IGBT: IGBT in TRENCHSTOP™ and Fieldstop technology





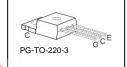




Features:

- Very low V_{CE(sat)} 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5μs
- Designed for :
 - Variable Speed Drive for washing machines and air conditioners
 - induction cooking
 - Uninterrupted Power Supply
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in V_{CE(sat)}
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/





Туре	$V_{\sf CE}$	I _C	V _{CE(sat),Tj=25°C}	$T_{\rm j,max}$	Marking Code	Package
IGP10N60T	600V	10A	1.5V	175°C	G10T60	PG-TO-220-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, <i>T</i> _j ≥ 25°C	V _{CE}	600	V
DC collector current, limited by $T_{\rm jmax}$			
$T_{\rm C} = 25^{\circ}{\rm C}$	I _C	24	
<i>T</i> _C = 100°C		18	A
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	30	
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175$ °C, $t_p = 1 \mu s$	FCT	D (30 N)	C
Gate-emitter voltage	V_{GE}	±20	V
Short circuit withstand time ²⁾	_	5	μS
$V_{\rm GE} = 15 \text{V}, \ V_{\rm CC} \le 400 \text{V}, \ T_{\rm j} \le 150^{\circ} \text{C}$	t_{SC}	5	
Power dissipation $T_C = 25^{\circ}C$	P_{tot}	110	W
Operating junction temperature	$T_{\rm j}$	-40+175	
Storage temperature	$T_{\rm stg}$	-55+150	°C
Soldering temperature, 1.6mm (0.063 in.) from case for 10s		260	

¹ J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IGP10N60T

TRENCHSTOP™ Series

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	R_{thJC}		1.35	K/W
junction – case				
Thermal resistance,	R_{thJA}		62	
junction – ambient				

Electrical Characteristic, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
raiailietei			min.	typ.	max.	Onne
Static Characteristic				7		
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\text{GE}}=0\text{V}, I_{\text{C}}=0.2\text{mA}$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 \rm V, \ I_{\rm C} = 10 \rm A$				
		<i>T</i> _j =25°C	-	1.5	2.05	
		$T_j = 175$ °C	-	1.8	-	
Gate-emitter threshold voltage	$V_{\rm GE(th)}$	$I_{\rm C}=0.3$ mA, $V_{\rm CE}=V_{\rm GE}$	4.1	4.6	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V,				μA
		$V_{\rm GE}=0$ V				
		T _j =25°C	/-7	-	40	
		$T_{\rm j}$ =175°C	4 -/	-	1000	
Gate-emitter leakage current	I _{GES}	$V_{\text{CE}}=0\text{V}, V_{\text{GE}}=20\text{V}$	-	-	100	nA
Transconductance	g_{fs}	$V_{\rm CE} = 20 \text{V}, I_{\rm C} = 10 \text{A}$	/-	6	-/-	S
Integrated gate resistor	R _{Gint}			none		Ω

Dynamic Characteristic

Input capacitance	Ciss	V _{CE} =25V,	-	551	-	pF
Output capacitance	Coss	$V_{GE}=0V$,		40	4	
Reverse transfer capacitance	Crss	f=1MHz	=-	17	-	
Gate charge	Q _{Gate}	$V_{\rm CC} = 480 \text{V}, I_{\rm C} = 10 \text{A}$	-	62	-	nC
		V _{GE} =15V	TR	0 N	LC	
Internal emitter inductance	LE	TO-220-3-1	-	7		nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current ¹⁾	$I_{C(SC)}$	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 5 \mu \text{s}$ $V_{\text{CC}} = 400 \text{V},$ $T_{\text{j}} = 25 ^{\circ} \text{C}$	1	100	1	A

 $^{^{1)}}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic $^{3)}$, Inductive Load, at T_{j} =25 $^{\circ}$ C

Doromotor	Cumbal	Conditions	Value			I Imia
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	T _j =25°C,	-	12	-	ns
Rise time	t _r	$V_{CC} = 400 \text{ V}, I_{C} = 10 \text{ A},$ $V_{GE} = 0/15 \text{ V}, I_{C} = 23 \Omega,$	-	8	-	
Turn-off delay time	t _{d(off)}	L_{σ} =60nH, C_{σ} =40pF	-	215	-	
Fall time	t _f		-	38	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include	-	0.16	-	mJ
Turn-off energy	Eoff	"tail" and diode reverse	- 1	0.27	-	
Total switching energy	E _{ts}	recovery. Diode from IKP10N60T	-	0.43	-	

Switching Characteristic ³⁾, Inductive Load, at T_j =175 °C

Parameter	Symbol	Conditions	Value			Unit
rarameter	Symbol	Conditions	min.	typ.	max.	Oilit
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	<i>T</i> _j =175°C,	-	10	-	ns
Rise time	t_{r}	$V_{CC} = 400 \text{ V}, I_{C} = 10 \text{ A},$ $V_{GE} = 0/15 \text{ V}, r_{G} = 23 \Omega,$	-	11	-	
Turn-off delay time	$t_{d(off)}$	L_{σ} =60nH, C_{σ} =40pF	/ - /	233	-	
Fall time	t_{f}		7	63	/-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include	7-	0.26	- /	mJ
Turn-off energy	$E_{\rm off}$	"tail" and diode reverse	-	0.35	-	
Total switching energy	Ets	recovery. Diode from IKP10N60T	-	0.61	-	







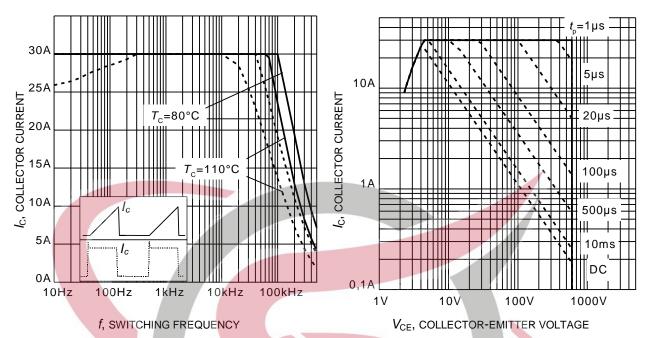


Figure 1. Collector current as a function of switching frequency $(T_j \le 175^{\circ}\text{C}, D = 0.5, V_{\text{CE}} = 400\text{V}, V_{\text{GE}} = 0/15\text{V}, r_{\text{G}} = 23\Omega)$

Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}\text{C}, T_j \leq 175^{\circ}\text{C}; V_{GE} = 0/15\text{V})$

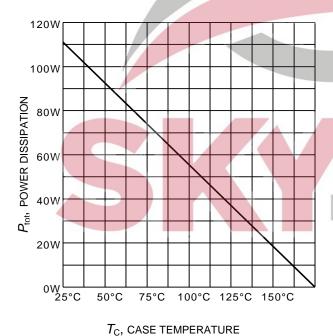
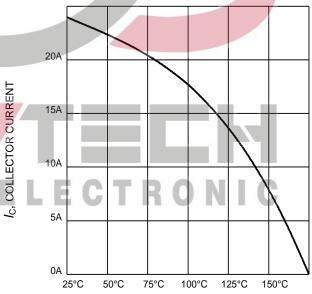


Figure 3. Power dissipation as a function of case temperature $(T_i \le 175^{\circ}\text{C})$



 $T_{\rm C}$, CASE TEMPERATURE Figure 4. Collector current as a function of case temperature ($V_{\rm GE} \ge 15 \rm V, \ T_i \le 175 ^{\circ} C$)





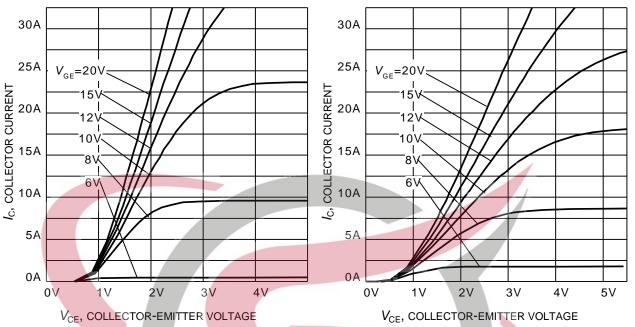


Figure 5. Typical output characteristic $(T_i = 25^{\circ}\text{C})$

Figure 6. Typical output characteristic $(T_i = 175^{\circ}C)$

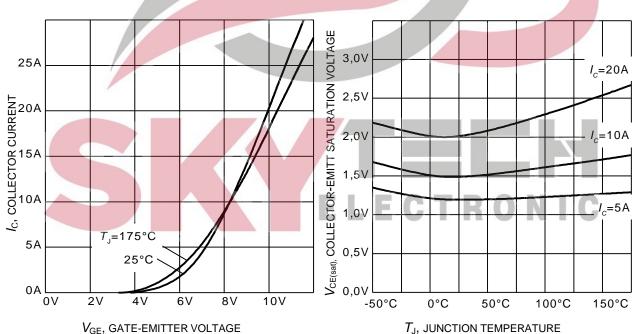
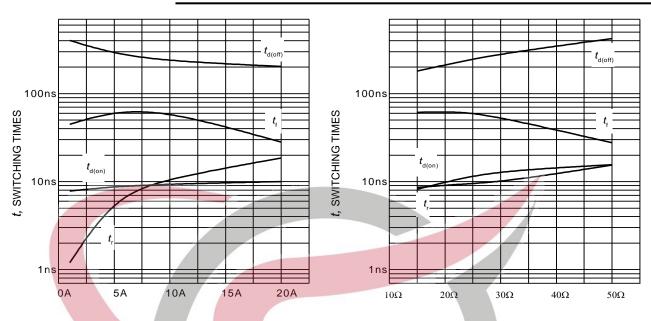


Figure 7. Typical transfer characteristic $(V_{CE}=20V)$

Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature $(V_{GE} = 15V)$





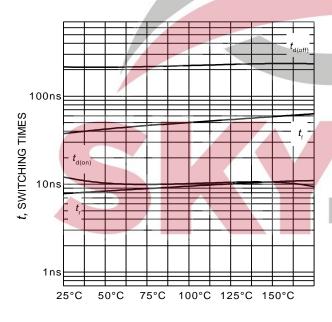


IC, COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current (inductive load, T_J =175°C, V_{CE} = 400V, V_{GE} = 0/15V, r_G = 23 Ω , Dynamic test circuit in Figure E)

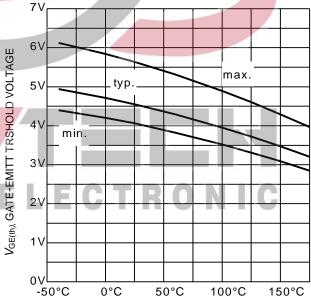
 $R_{\rm G}$, gate resistor

Figure 10. Typical switching times as a function of gate resistor (inductive load, $T_J = 175$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/15$ V, $I_C = 10$ A, Dynamic test circuit in Figure E)



 $T_{
m J}$, JUNCTION TEMPERATURE

Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/15V, $I_{\rm C}$ = 10A, $r_{\rm G}$ =23 Ω , Dynamic test circuit in Figure E)



 $T_{\rm J}$, JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature $(I_C = 0.3\text{mA})$





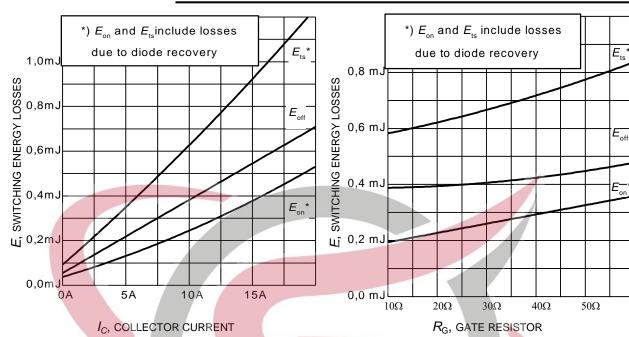


Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_J = 175^{\circ}\text{C}$, $V_{\text{CE}} = 400\text{V}$, $V_{\text{GE}} = 0/15\text{V}$, $r_{\text{G}} = 23\Omega$, Dynamic test circuit in Figure E)

Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, $T_J = 175$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/15$ V, $I_C = 10$ A, Dynamic test circuit in Figure E)

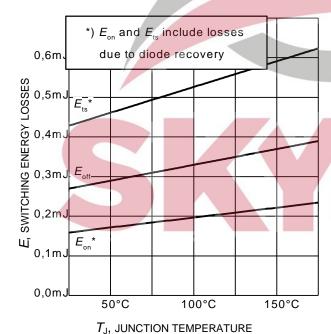
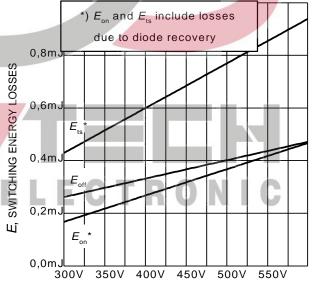


Figure 15. Typical switching energy losses as a function of junction temperature

(inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/15V, $I_{\rm C}$ = 10A, $r_{\rm G}$ = 23 Ω , Dynamic test circuit in Figure E)



 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load, T_J = 175°C, V_{GE} = 0/15V, I_C = 10A, r_G = 23 Ω , Dynamic test circuit in Figure E)





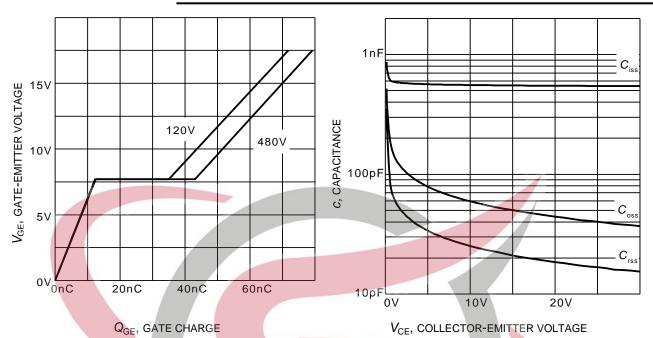


Figure 17. Typical gate charge $(I_C=10 \text{ A})$

Figure 18. Typical capacitance as a function of collector-emitter voltage (V_{GE}=0V, f = 1 MHz)

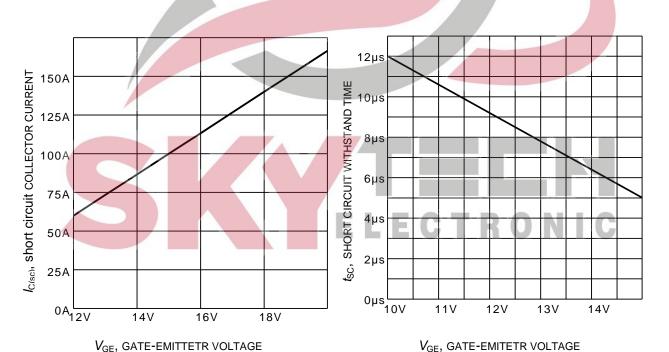


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage $(V_{CE} \le 400 \text{V}, T_i \le 150 ^{\circ}\text{C})$

Figure 20. Short circuit withstand time as a function of gate-emitter voltage ($V_{\rm CE}$ =400V, start at $T_{\rm J}$ =25°C, $T_{\rm Jmax}$ <150°C)



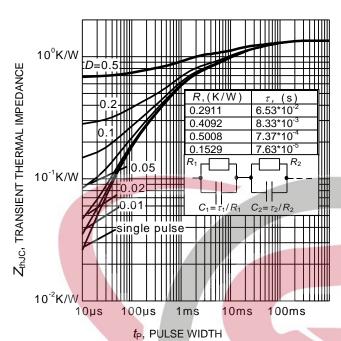


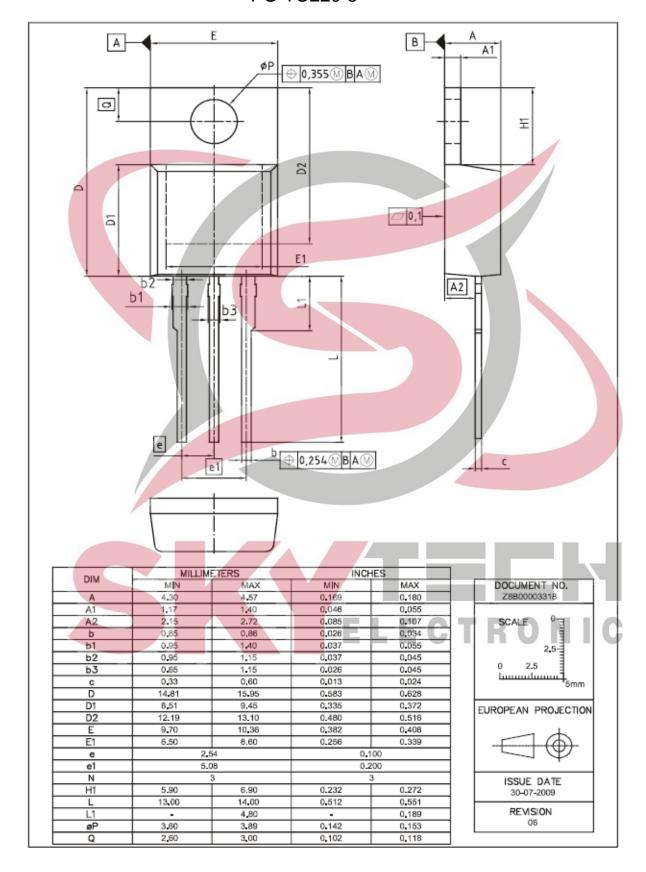
Figure 21. IGBT transient thermal impedance $(D = t_p / T)$





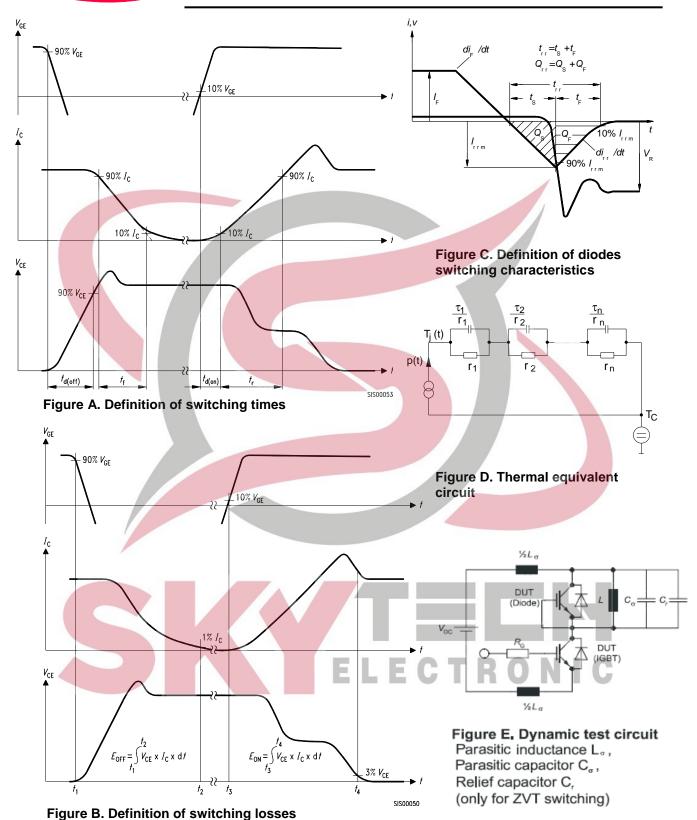


PG-TO220-3











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